

SIP Additive Manufacturing International Workshop



Organizer: NIMS, JST

Venue: Tsukuba International Congress Center 202, Tsukuba, Ibaraki, Japan

Dates: January 28th (Tue) 9:25 -29th (Wed), 2020

Registration Fee: Free (Banquet (Jan. 28th), fee: ¥2000)

Send e-mail for **Registration** : sip_amiw@ml.nims.go.jp

(Name, Affiliation, Date of Attendance, Banquet Attendance)

Web : <https://www.nims.go.jp/research/KO-ZO/events/20200128.html>

Keynote speakers



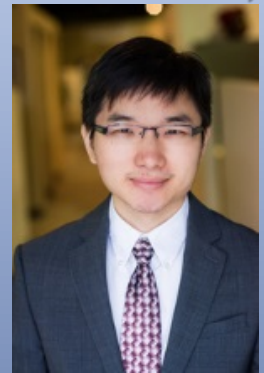
**Behrang
Poorganji (US)**

**Shoufeng Yang
(KU Leuven, BE)**



**Peter Collins
(Iowa State
Univ., US)**

**Jiadong Gong
(QuesTek
Innovations, US)**



Invited speakers

- Shinya Imano (Mitsubishi Hitachi Power Systems, JP)
- Trevor Keller (National Institute of Standard and Technology, US)
- Quanquan Han (Cardiff University, UK)
- Avinash Hariharan (Max Planck Institute, GER)
- Zhongji Sun (Max Planck Institute, GER)
- Tyler Alexander London (The Welding Institute, UK)
- Pierre-Adrien Pires (ESI Group, FRA)
- Sukeharu Nomoto (Nagoya university, JP)
- Kenta Aoyagi (Tohoku University, JP)
- Houichi Kitaino (National institute for Materials Science, JP)
- Kaita Ito (National institute for Materials Science, JP)
- Masahiro Kusano (National institute for Materials Science, JP)